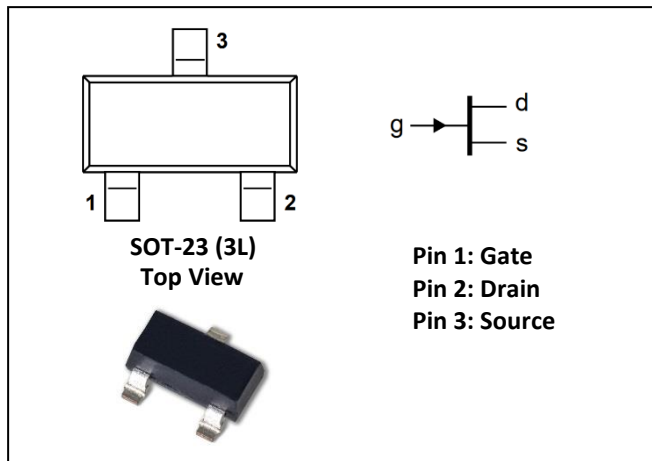


General Purpose, Low-Noise, Low-Cost, Single N-Channel JFET, Replacement for the BF510

Absolute Maximum Ratings	
@ 25 °C (unless otherwise stated)	
Maximum Temperatures	
Storage Temperature	-65 to +150°C
Junction Operating Temperature	-55 to +150°C
Maximum Power Dissipation	
Continuous Power Dissipation @ +25°C	350mW
Maximum Currents	
Gate Forward Current	$I_{G(F)} = 10\text{mA}$
Maximum Voltages	
Gate to Source	$V_{GSS} = 30\text{V}$
Gate to Drain	$V_{GDS} = 30\text{V}$



Features

- Low Cutoff Voltage: <2.5V
- High Input Impedance
- Very Low Noise
- High Gain: $A_V = 80 @ 20 \mu\text{A}$
- Reverse Gate to Source and Drain Voltage $\geq -30\text{V}$

Benefits

- Low Cost
- Excellent Low Power Supply Operation
- Power Supply: Down to 2.5V
- Low Signal Loss/System Error
- High System Sensitivity
- High Quality Low-Level Signal

Applications

- High-Gain, Low Noise Amplifiers
- Low-Current, Low-Voltage
- Battery-Powered Amplifiers
- Infrared Detector Amplifiers
- Ultra-High Input Impedance Pre-Amplifiers

Description

The LSBF510 is a low-cost N-Channel JFET. Features include low leakage, very low noise, low cutoff voltage ($V_{GS(off)} \leq 2.5\text{V}$) and high Gain ($A_V = 80 \text{ V/V}$) for use with low-level power supplies. The LSBF510 is excellent for battery powered

equipment and low current amplifiers. The TO-236 (SOT-23) package provides surface-mount capability. The LSBF510 is available in tape-and-reel for automated assembly and in die form for automated assembly.

Electrical Characteristics @ 25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
BV_{GSS}	Gate to Source Breakdown Voltage	-30			V	$I_G = -1\mu\text{A}, V_{DS} = 0.0\text{V}$
$V_{GS(off)}$	Gate to Source Cutoff Voltage	-0.3		-2.5		$V_{DS} = 15\text{V}, I_D = 10\text{nA}$
I_{DSS}	Drain to Source Saturation Current ²	0.2		3.0	mA	$V_{DS} = 15\text{V}, V_{GS} = 0.0\text{V}$
I_{GSS}	Gate Reverse Current			-200		$V_{GS} = -20\text{V}, V_{DS} = 0.0\text{V}$
I_G	Gate Operating Current		-2			$V_{DG} = 10\text{V}, I_D = 0.1\text{mA}$
$I_{D(off)}$	Drain Cutoff Current		2		pA	$V_{DS} = 15\text{V}, V_{GS} = 5.0\text{V}$
g_{fs}	Forward Transconductance	0.5				mS
C_{iss}	Input Capacitance			4.5	pF	$V_{DS} = 15\text{V}, V_{GS} = 0.0\text{V}, f = 1\text{MHz}$
C_{rss}	Reverse Transfer Capacitance		1.3			
e_n	Noise Voltage		3.0		nV/ $\sqrt{\text{Hz}}$	$V_{DS} = 10\text{V}, I_D = 2\text{mA}, f = 1\text{kHz}$

Typical Characteristics

Output Characteristic
($V_{GS(off)} = -1.1V$)

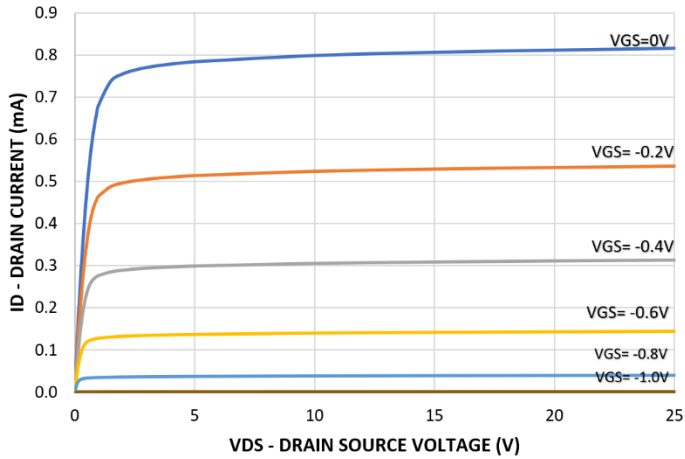


Figure-01

Output Characteristic
($V_{GS(off)} = -1.75V$)

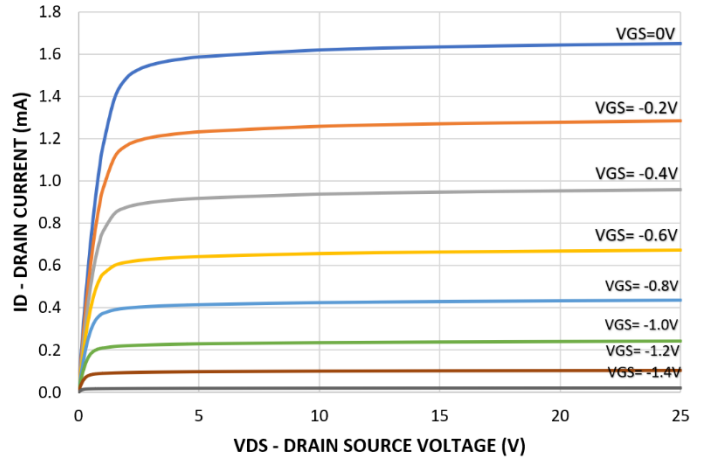


Figure-02

Output Characteristic
($V_{GS(off)} = -1.1V$)

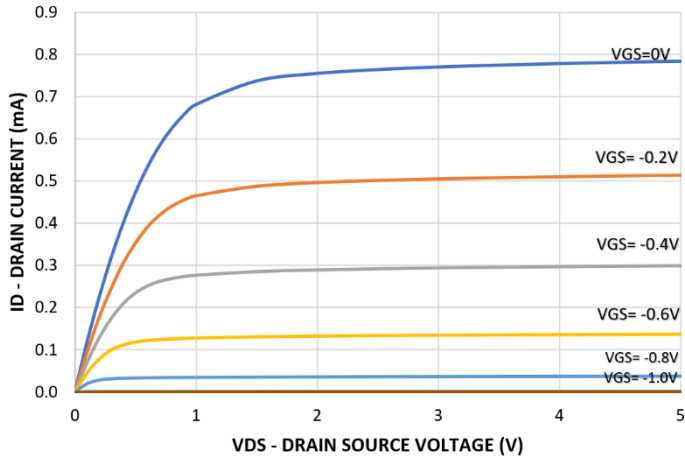


Figure-03

Output Characteristic
($V_{GS(off)} = -1.75V$)

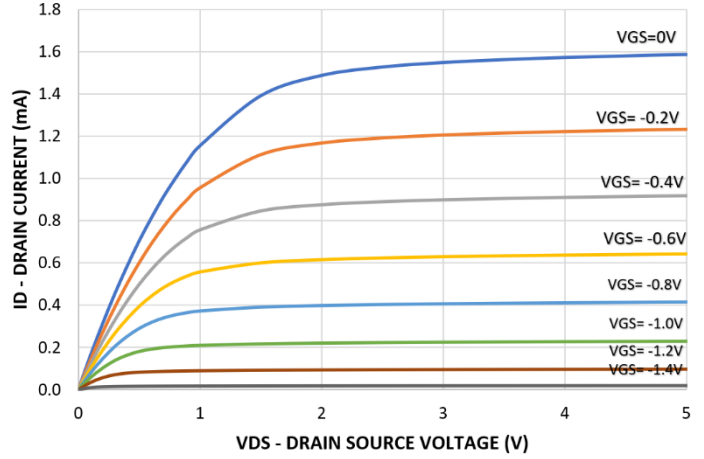
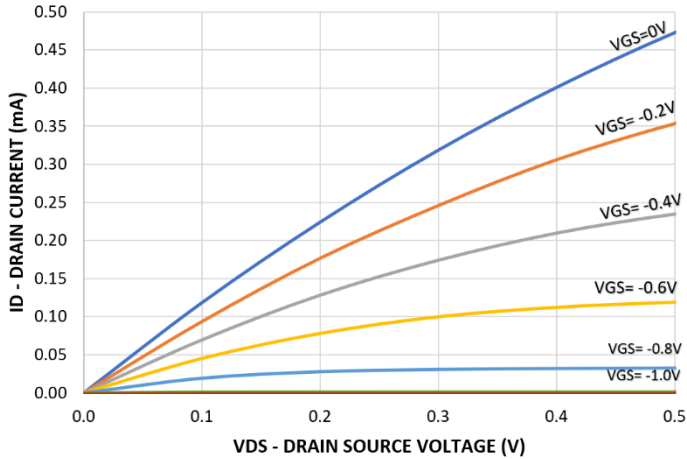


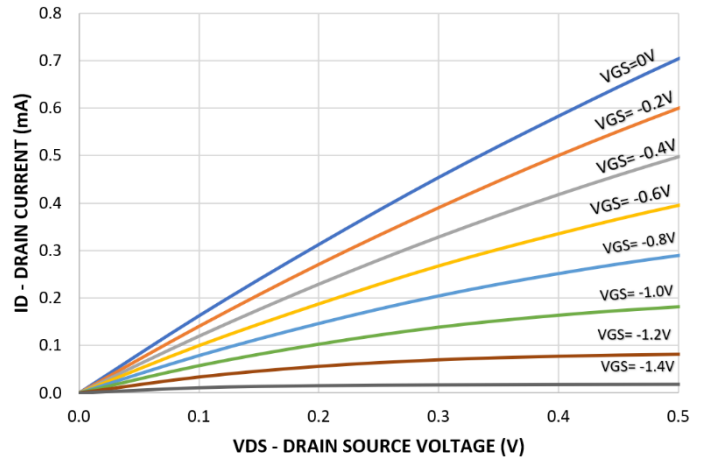
Figure-04

Typical Characteristics Continued

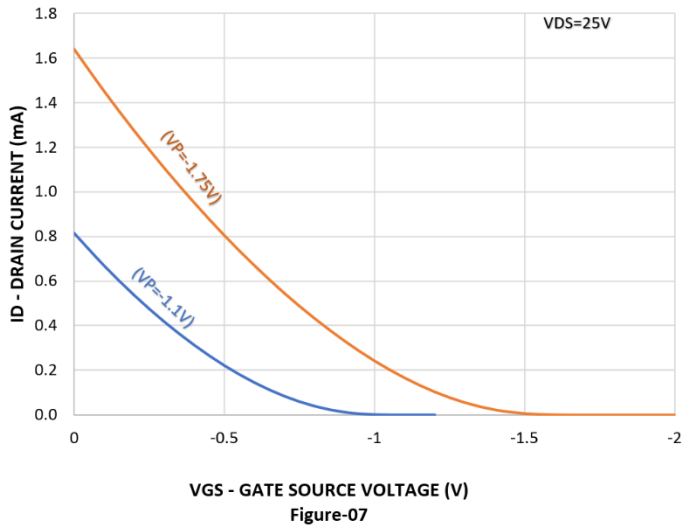
Output Characteristic
($V_{GS(off)} = -1.1V$)



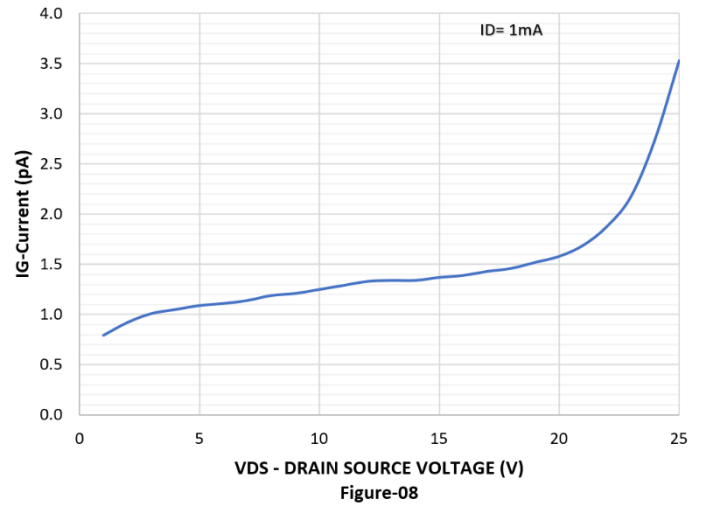
Output Characteristic
($V_{GS(off)} = -1.75V$)



Transfer Characteristics



Operating Gate Current



Typical Characteristics Continued

